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November 2013

## FDMC610P

## P-Channel PowerTrench® MOSFET

-12 V, -80 A, 3.9 mΩ

#### **Features**

- Max  $r_{DS(on)}$  = 3.9 m $\Omega$  at  $V_{GS}$  = -4.5 V,  $I_D$  = -22 A
- Max  $r_{DS(on)}$  = 6.4 m $\Omega$  at  $V_{GS}$  = -2.5 V,  $I_D$  = -16 A
- State-of-the-art switching performance
- Lower output capacitance, gate resistance, and gate charge boost efficiency
- Shielded gate technology reduces switch node ringing and increases immunity to EMI and cross conduction
- RoHS Compliant

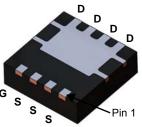
#### **General Description**

This P-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

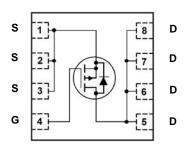
#### **Applications**

- High side switching for high end computing
- High power density DC-DC synchronous buck converter





**Bottom** 



Power 33

#### MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

Symbol	Parame		Ratings	Units	
$V_{DS}$	Drain to Source Voltage			-12	V
$V_{GS}$	Gate to Source Voltage			±8	V
	Drain Current - Continuous	T <sub>C</sub> = 25 °C		-80	
$I_D$	- Continuous		(Note 1a)	-22	Α
	- Pulsed			-200	
Б	Power Dissipation	T <sub>C</sub> = 25 °C		48	10/
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.4	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	T <sub>C</sub> = 25 °C		2.6	°C/W
$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient	T <sub>A</sub> = 25 °C	(Note 1a)	53	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package Reel Size Tape W		Tape Width	Quantity
23AB	FDMC610P	Power 33 13 "		12 mm	3000 units

## Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = -250 $\mu A$ , $V_{GS}$ = 0 $V$	-12			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 μA , referenced to 25 °C		-13		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -9.6 V, V <sub>GS</sub> = 0 V			-1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±8 V, V <sub>DS</sub> = 0 V			±100	nA

#### **On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.7	-1	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = -250 μA , referenced to 25 °C		3.1		mV/°C
		$V_{GS} = -4.5 \text{ V}, I_D = -22 \text{ A}$		2.8	3.9	
r <sub>DS(on)</sub>	r <sub>DS(on)</sub> Static Drain to Source On Resistance	$V_{GS} = -2.5 \text{ V}, I_D = -16 \text{ A}$		3.7	6.4	mΩ
	$V_{GS} = -4.5 \text{ V}, I_D = -22 \text{ A}, T_J = 125 \text{ °C}$		3.6	5.4		
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = -5 \text{ V}, I_D = -22 \text{ A}$		16		S

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V - CV V - CV		0.89	1.25	nF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = -6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1620	2270	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 101112		1440	2015	pF
$R_q$	Gate Resistance		0.1	3.6	7.2	Ω

### **Switching Characteristics**

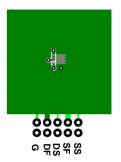
t <sub>d(on)</sub>	Turn-On Delay Time			24	39	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -6 V, I <sub>D</sub> = -22 A,		37	60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = -4.5 V, $R_{GEN}$ = 6 $\Omega$		193	309	ns
t <sub>f</sub>	Fall Time			87	139	ns
$Q_g$	Total Gate Charge	V 0.V.I 00.A		71	99	nC
$Q_{gs}$	Gate to Source Charge	$V_{DD} = -6 \text{ V, } I_{D} = -22 \text{ A,}$ $V_{GS} = -4.5 \text{ V}$		13		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>GS</sub> = -4.3 V		14		nC

#### **Drain-Source Diode Characteristics**

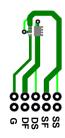
V Sou	Veb Source to Drain Diode Forward Voltage F	$V_{GS} = 0 \text{ V}, I_S = -2 \text{ A}$ (Note 2)		-0.6	-1.2	V
V SD		$V_{GS} = 0 \text{ V}, I_S = -22 \text{ A}$ (Note 2)		-0.8	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	- I <sub>F</sub> = -22 A, di/dt = 100 A/μs		36	58	ns
Q <sub>rr</sub>	Reverse Recovery Charge			19	33	nC

#### Note:

<sup>1</sup> R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



a. 53 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

### Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

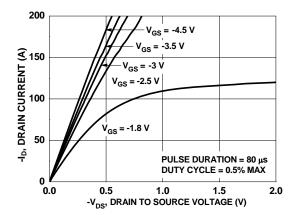


Figure 1. On Region Characteristics

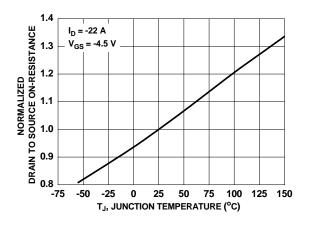


Figure 3. Normalized On Resistance vs Junction Temperature

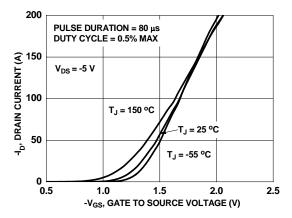


Figure 5. Transfer Characteristics

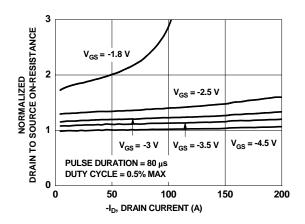


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

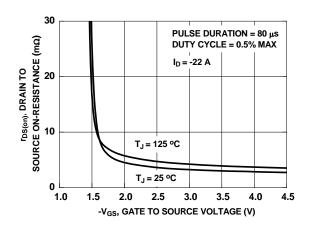


Figure 4. On-Resistance vs Gate to Source Voltage

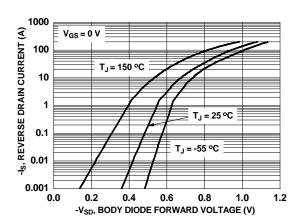


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

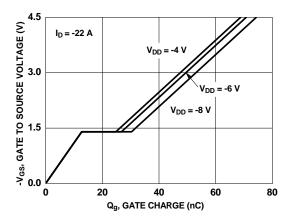


Figure 7. Gate Charge Characteristics

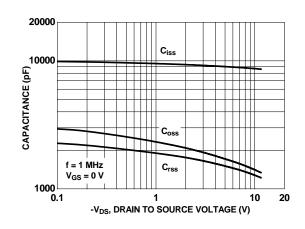


Figure 8. Capacitance vs Drain to Source Voltage

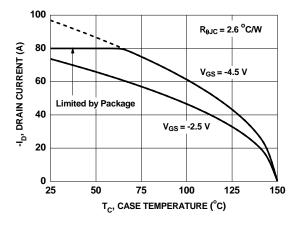


Figure 9. Maximum Continuous Drain Current vs Case Temperature

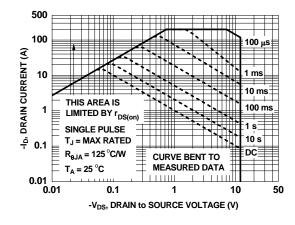


Figure 10. Forward Bias Safe Operating Area

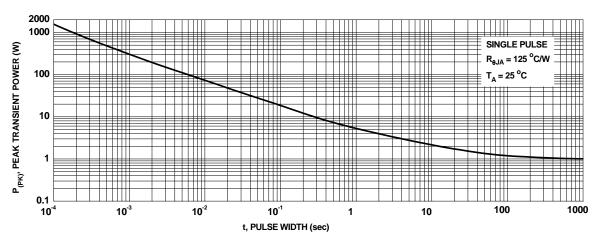


Figure 11. Single Pulse Maximum Power Dissipation



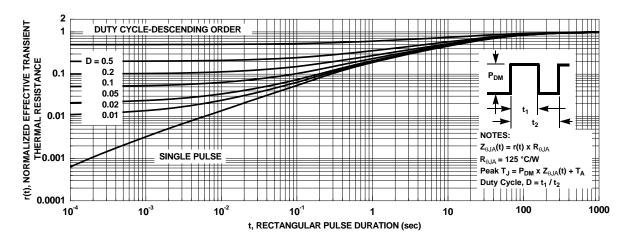
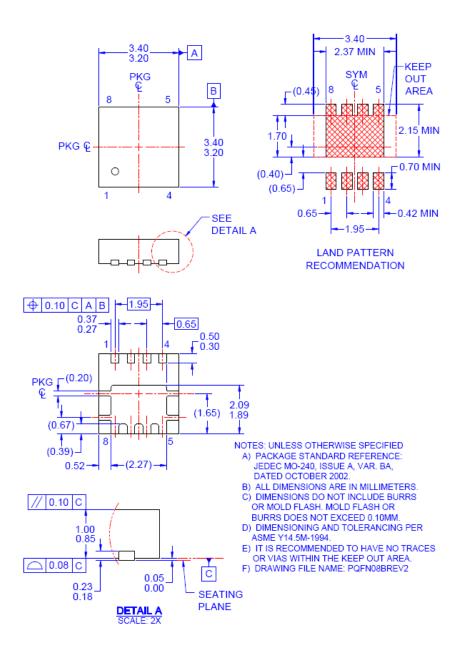


Figure 12. Junction-to-Ambient Transient Thermal Response Curve

## **Dimensional Outline and Pad Layout**







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